

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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4.50±0.75

[0.177±0.030]

30.48 [1.200]

REVISIONS

10.50 [0.413] -

34.00 [1.339]

E.C.N. #10BRDR. & REDRAWN./

- PIN 6

PIN 5

2.54 [0.100]

10.16 [0.400]

++++

24.00 [0.945]

ELECTRO-OPTICAL CHARACTERISTICS $T_A = 25^{\circ}C$ $I_f = 10 \text{ mA}$

| PARAMETER | MIN | TYP | MAX | UNITS | TEST COND |
|--|---------------------------------|---|---------|---|---|
| PEAK WAVELENGTH FORWARD VOLTAGE* REVERSE VOLTAGE AXIAL INTENSITY EMITTED COLOR: FONT COLOR: SEGMENT COLOR: | 5.0 GREEN GREY MILKY V | 565 (GREEN 4.4/2.2 6300 WHITE DIFFUS | 5.2/2.6 | nm V _f V _r µcd | I _r =100μΑ I _f =10mA |

* SECOND VALUE FOR SINGLE CHIP IN DECIMAL POINT.

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

| PARAMETER | MAX | UNITS | |
|--|--|---|--|
| PEAK FORWARD CURRENT* STEADY CURRENT POWER DISSIPATION DERATE FROM 25°C OPERATING, STORAGE TEMP. SOLDERING TEMP. 2.0mm FROM BODY | 150 25 105 -1.2 -20 TO +80 +260 | mA mA mW mW/*C *C *C 3 SEC. MAX | |

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE

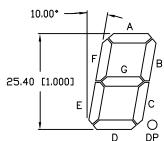
FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

* t<10µS

RELIABILITY NOTE

| PARAMETER | MAX | UNITS |
|--|--|---|
| PEAK FORWARD CURRENT* STEADY CURRENT POWER DISSIPATION DERATE FROM 25°C OPERATING, STORAGE TEMP. SOLDERING TEMP. 2.0mm FROM BODY | 150 25 105 -1.2 -20 TO +80 +260 | mA mA mW mW/*C *C *C *C 3 SEC. MAX |

DIGIT DETAIL



INCORPORATED

290 E. HELLEN ROAD PALATINE, ILLINOIS 60067 (847) 359-2790

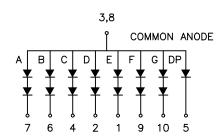
Α

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THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT
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DWN: CHK'D: APPD: DATE: 12-19-95 SCALE: N/A

> 1.0" SINGLE DIGIT, SEVEN SEGMENT DISPLAY, 565nm GREEN, GREY FONT/WHITE SEGMENTS, COMMON ANODE.

DRAWING NUMBER REV PAGE 1 OF 1 LDS-AA12RI Α



DATE

4-22-98

PIN 10 -

PIN 1

Ø0.50 [0.020] -

UNLESS OTHERWISE SPECIFIED TOLERANCE IS ±.25mm (±0.010")

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